## NSN 5962-01-262-9857

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View Online at https://aerobasegroup.com/nsn/5962-01-262-9857

### **Body Length:** 1.415 inches **Body Width:** 0.605 inches **Body Height:** 0.210 inches **Maximum Power Dissipation Rating:** 790.0 milliwatts **Operating Tempurature Range:** -55.0/+125.0 degrees celsius Storage Tempurature Range: -65.0/+125.0 degrees celsius **Features Provided:** Hermetically sealed and burn in and w/buffered output and w/enable and high speed and ultraviolet erasable **Inclosure Material:** Ceramic **Inclosure Configuration:** Dual-in-line **Output Logic Form:** N-type metal oxide-semiconductor logic **Input Circuit Pattern:** 16 input **Terminal Surface Treatment:** Solder Voltage Rating And Type Per Characteristic: 5.0 volts power source **Time Rating Per Chacteristic:** 250.00 nanoseconds propagation delay time, low to high level output and 250.00 nanoseconds propagation delay time, high to low level output Memory Device Type: Rom **Memory Capacity:** Unknown **Test Data Document:** 96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.). **Terminal Type And Quantity:** 28 printed circuit Shelf Life: N/a

### Unit Of Measure:

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#### **Demilitarization:**

Yes - demil/mli

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**Fiig:** A458a0

